

Phase Control Thyristors (Hockey PUK Version), 500 A



A-PUK (TO-200AB)

FEATURES

- Center amplifying gate
- Metal case with ceramic insulator
- International standard case A-PUK (TO-200AB))
- Designed and qualified for industrial level
- Material categorization: for definitions of compliance please see www.vishay.com/doc?99912


RoHS
COMPLIANT

TYPICAL APPLICATIONS

- DC motor controls
- Controlled DC power supplies
- AC controllers

PRIMARY CHARACTERISTICS

| | |
|-----------------------|-------------------|
| $I_{T(AV)}$ | 500 A |
| V_{DRM}/V_{RRM} | 400 V, 600 V |
| V_{TM} | 1.36 V |
| I_{GT} | 90 mA |
| T_J | -40 °C to +125 °C |
| Package | A-PUK (TO-200AB) |
| Circuit configuration | Single SCR |

MAJOR RATINGS AND CHARACTERISTICS

| PARAMETER | TEST CONDITIONS | VALUES | UNITS |
|-------------------|-----------------|-------------|-------------------|
| $I_{T(AV)}$ | | 500 | A |
| | T_{hs} | 55 | °C |
| $I_{T(RMS)}$ | | 960 | A |
| | T_{hs} | 25 | °C |
| I_{TSM} | 50 Hz | 7850 | A |
| | 60 Hz | 8220 | |
| I^2t | 50 Hz | 308 | kA ² s |
| | 60 Hz | 281 | |
| V_{DRM}/V_{RRM} | | 400 to 600 | V |
| t_q | Typical | 100 | µs |
| T_J | | - 40 to 125 | °C |

ELECTRICAL SPECIFICATIONS

VOLTAGE RATINGS

| TYPE NUMBER | VOLTAGE CODE | V_{DRM}/V_{RRM} , MAXIMUM REPETITIVE PEAK AND OFF-STATE VOLTAGE V | V_{RSM} , MAXIMUM NON-REPETITIVE PEAK VOLTAGE V | I_{DRM}/I_{RRM} MAXIMUM AT $T_J = T_J$ MAXIMUM mA |
|-------------|--------------|--|--|--|
| ST280C..C | 04 | 400 | 500 | 30 |
| | 06 | 600 | 700 | |

**ABSOLUTE MAXIMUM RATINGS**

| PARAMETER | SYMBOL | TEST CONDITIONS | | VALUES | UNITS |
|--|---------------|--|---------------------------|------------|--------------------|
| Maximum average on-state current at heatsink temperature | $I_{T(AV)}$ | 180° conduction, half sine wave double side(single side) cooled | | 500 (185) | A |
| | | | | 55 (85) | °C |
| Maximum RMS on-state current | $I_{T(RMS)}$ | DC at 25 °C heatsink temperature double side cooled | | 960 | |
| Maximum peak, one-cycle non-repetitive surge current | I_{TSM} | t = 10 ms | No voltage reapplied | 7850 | A |
| | | t = 8.3 ms | No voltage reapplied | 8220 | |
| | | t = 10 ms | 100 % V_{RRM} reapplied | 6600 | |
| | | t = 8.3 ms | 100 % V_{RRM} reapplied | 6900 | |
| Maximum I^2t for fusing | I^2t | t = 10 ms | No voltage reapplied | 308 | kA ² s |
| | | t = 8.3 ms | No voltage reapplied | 281 | |
| | | t = 10 ms | 100 % V_{RRM} reapplied | 218 | |
| | | t = 8.3 ms | 100 % V_{RRM} reapplied | 200 | |
| Maximum $I^2\sqrt{t}$ for fusing | $I^2\sqrt{t}$ | t = 0.1 to 10 ms, no voltage reapplied | | 3080 | kA ² √s |
| Low level value of threshold voltage | $V_{T(TO)1}$ | $(16.7 \% \times \pi \times I_{T(AV)} < I < \pi \times I_{T(AV)})$, $T_J = T_J$ maximum | | 0.84 | V |
| High level value of threshold voltage | $V_{T(TO)2}$ | $(I > \pi \times I_{T(AV)})$, $T_J = T_J$ maximum | | 0.88 | |
| Low level value of on-state slope resistance | r_{t1} | $(16.7 \% \times \pi \times I_{T(AV)} < I < \pi \times I_{T(AV)})$, $T_J = T_J$ maximum | | 0.50 | mΩ |
| High level value of on-state slope resistance | r_{t2} | $(I > \pi \times I_{T(AV)})$, $T_J = T_J$ maximum | | 0.47 | |
| Maximum on-state voltage | V_{TM} | $I_{pk} = 1050$ A, $T_J = 125$ °C, $t_p = 10$ ms sine pulse | | 1.36 | V |
| Maximum holding current | I_H | $T_J = 25$ °C, anode supply 12 V resistive load | | 600 | mA |
| Maximum (typical) latching current | I_L | | | 1000 (300) | |

SWITCHING

| PARAMETER | SYMBOL | TEST CONDITIONS | VALUES | UNITS |
|--|---------|--|--------|-------|
| Maximum non-repetitive rate of rise of turned-on current | di/dt | Gate drive 20 V, 20 Ω, $t_r \leq 1$ μs $T_J = T_J$ maximum, anode voltage ≤ 80 % V_{DRM} | 1000 | A/μs |
| Typical delay time | t_d | Gate current 1 A, $di_g/dt = 1$ A/μs $V_d = 0.67$ % V_{DRM} , $T_J = 25$ °C | 1.0 | μs |
| Typical turn-off time | t_q | $I_{TM} = 300$ A, $T_J = T_J$ maximum, $di/dt = 20$ A/μs, $V_R = 50$ V, $dV/dt = 20$ V/μs, gate 0 V 100 Ω, $t_p = 500$ μs | 100 | |

BLOCKING

| PARAMETER | SYMBOL | TEST CONDITIONS | VALUES | UNITS |
|--|--------------------------|--|--------|-------|
| Maximum critical rate of rise of off-state voltage | dV/dt | $T_J = T_J$ maximum linear to 80 % rated V_{DRM} | 500 | V/μs |
| Maximum peak reverse and off-state leakage current | I_{RRM} , I_{DRM} | $T_J = T_J$ maximum, rated V_{DRM}/V_{RRM} applied | 30 | mA |



| TRIGGERING | | | | | | |
|-------------------------------------|--------------------|--|---|--------|------|-------|
| PARAMETER | SYMBOL | TEST CONDITIONS | | VALUES | | UNITS |
| | | | | TYP. | MAX. | |
| Maximum peak gate power | P _{GM} | T _J = T _J maximum, t _p ≤ 5 ms | | 10.0 | | W |
| Maximum average gate power | P _{G(AV)} | T _J = T _J maximum, f = 50 Hz, d% = 50 | | 2.0 | | |
| Maximum peak positive gate current | I _{GM} | T _J = T _J maximum, t _p ≤ 5 ms | | 3.0 | | A |
| Maximum peak positive gate voltage | + V _{GM} | T _J = T _J maximum, t _p ≤ 5 ms | | 20 | | V |
| Maximum peak negative gate voltage | - V _{GM} | | | 5.0 | | |
| DC gate current required to trigger | I _{GT} | T _J = - 40 °C | Maximum required gate trigger/ current/voltage are the lowest value which will trigger all units 12 V anode to cathode applied | 180 | - | mA |
| | | T _J = 25 °C | | 90 | 150 | |
| | | T _J = 125 °C | | 40 | - | |
| DC gate voltage required to trigger | V _{GT} | T _J = - 40 °C | | 2.9 | - | V |
| | | T _J = 25 °C | | 1.8 | 3.0 | |
| | | T _J = 125 °C | | 1.2 | - | |
| DC gate current not to trigger | I _{GD} | T _J = T _J maximum | Maximum gate current/voltage not to trigger is the maximum value which will not trigger any unit with rated V _{DRM} anode to cathode applied | 10 | | mA |
| DC gate voltage not to trigger | V _{GD} | | | 0.30 | | V |

| THERMAL AND MECHANICAL SPECIFICATIONS | | | | |
|--|--------------|---|------------------|-----------|
| PARAMETER | SYMBOL | TEST CONDITIONS | VALUES | UNITS |
| Maximum operating junction temperature range | T_J | | - 40 to 125 | °C |
| Maximum storage temperature range | T_{Stg} | | - 40 to 150 | |
| Maximum thermal resistance, junction to heatsink | R_{thJ-hs} | DC operation single side cooled | 0.17 | K/W |
| | | DC operation double side cooled | 0.08 | |
| Maximum thermal resistance, case to heatsink | R_{thC-hs} | DC operation single side cooled | 0.033 | |
| | | DC operation double side cooled | 0.017 | |
| Mounting force, ± 10 % | | | 4900 (500) | N (kg) |
| Approximate weight | | | 50 | g |
| Case style | | See dimensions - link at the end of datasheet | A-PUK (TO-200AB) | |

| ΔR_{thJC} CONDUCTION | | | | | | |
|------------------------------|-----------------------|-------------|------------------------|-------------|---|-------|
| CONDUCTION ANGLE | SINUSOIDAL CONDUCTION | | RECTANGULAR CONDUCTION | | TEST CONDITIONS | UNITS |
| | SINGLE SIDE | DOUBLE SIDE | SINGLE SIDE | DOUBLE SIDE | | |
| 180° | 0.016 | 0.016 | 0.011 | 0.011 | T _J = T _J maximum | K/W |
| 120° | 0.019 | 0.019 | 0.019 | 0.019 | | |
| 90° | 0.024 | 0.024 | 0.026 | 0.026 | | |
| 60° | 0.035 | 0.035 | 0.036 | 0.037 | | |
| 30° | 0.060 | 0.060 | 0.060 | 0.061 | | |

Note

- The table above shows the increment of thermal resistance R_{thJC} when devices operate at different conduction angles than DC

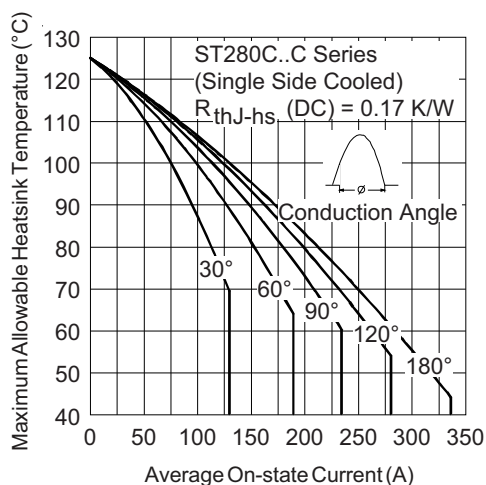


Fig. 1 - Current Ratings Characteristics

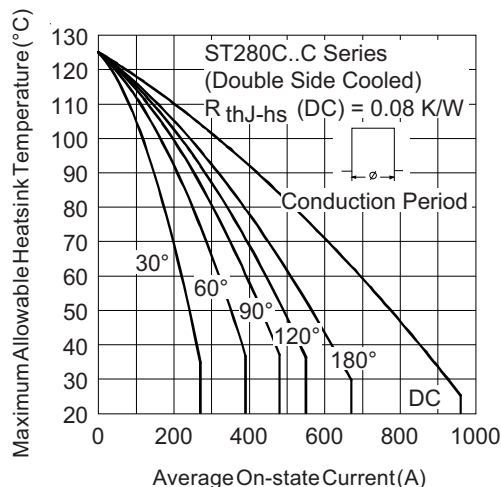


Fig. 4 - Current Ratings Characteristics

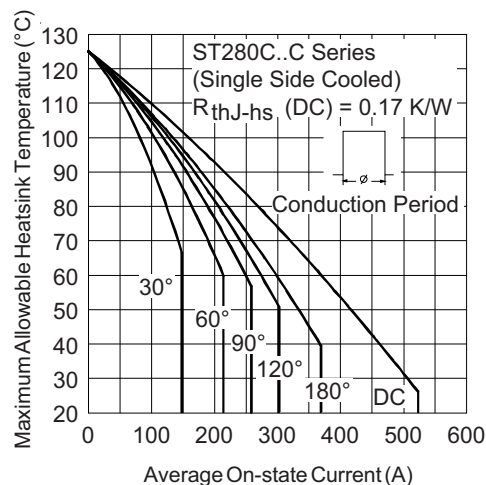


Fig. 2 - Current Ratings Characteristics

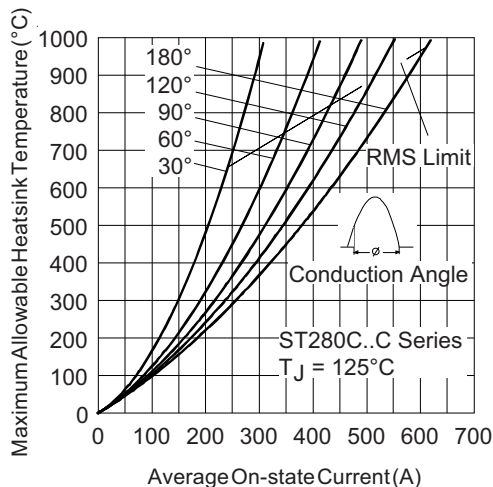


Fig. 5 - On-State Power Loss Characteristics

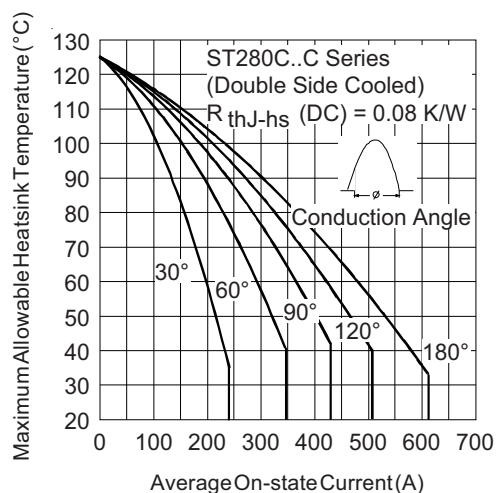


Fig. 3 - Current Ratings Characteristics

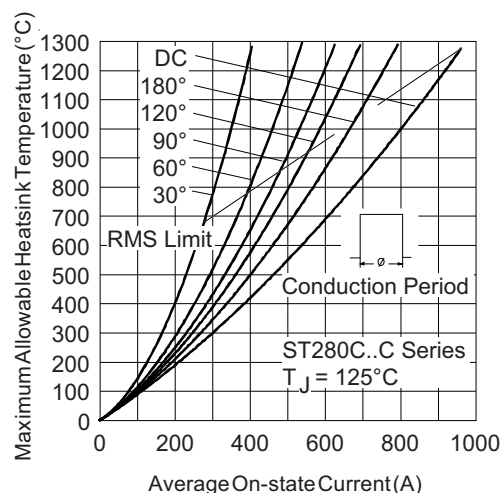


Fig. 6 - On-State Power Loss Characteristics

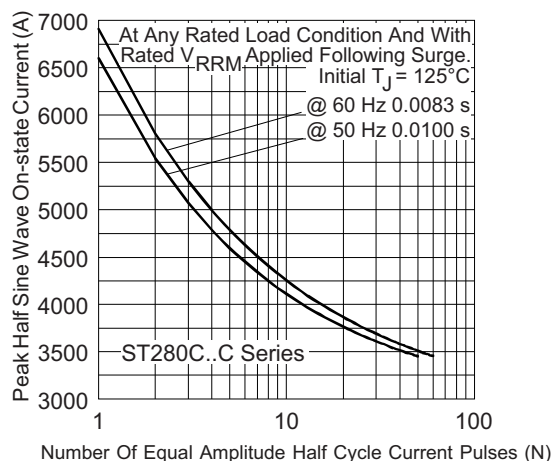


Fig. 7 - Maximum Non-Repetitive Surge Current
Single and Double Side Cooled

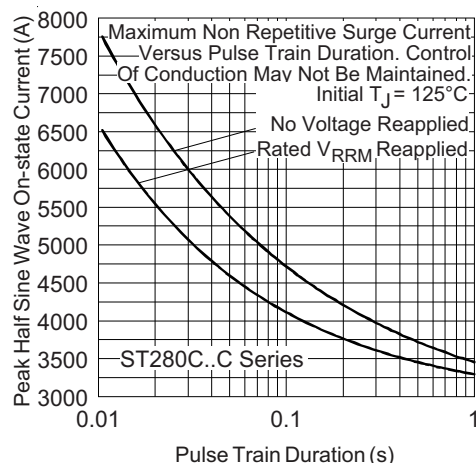


Fig. 8 - Maximum Non-Repetitive Surge Current
Single and Double Side Cooled

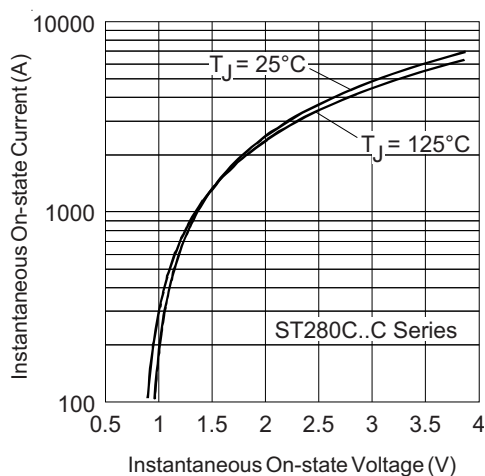


Fig. 9 - On-State Voltage Drop Characteristics

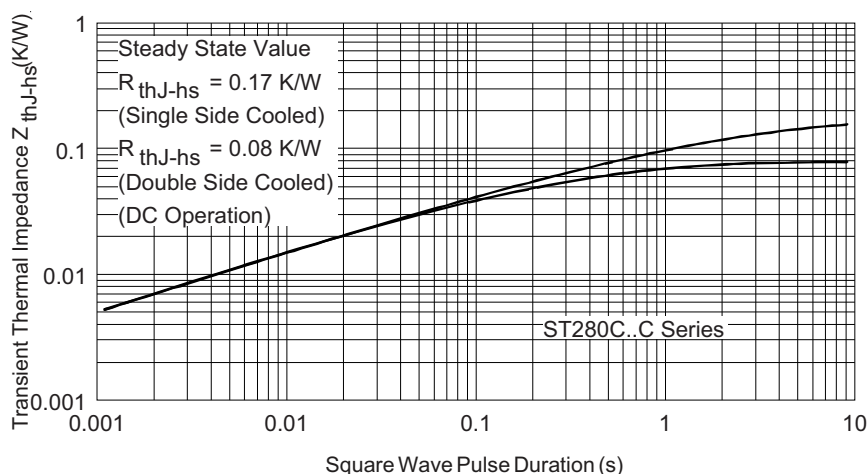


Fig. 10 - Thermal Impedance Z_{thJ-hs} Characteristics

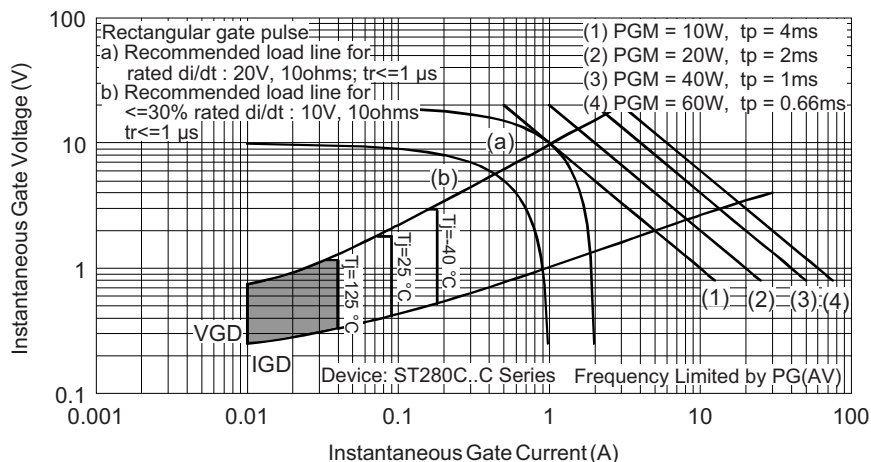


Fig. 11 - Gate Characteristics

ORDERING INFORMATION TABLE

| Device code | VS- | ST | 28 | 0 | C | 06 | C | 1 | - |
|-------------|--|-----|-----|-----|-----|-----|-----|-----|-----|
| | (1) | (2) | (3) | (4) | (5) | (6) | (7) | (8) | (9) |
| 1 | Vishay Semiconductors product | | | | | | | | |
| 2 | Thyristor | | | | | | | | |
| 3 | Essential part number | | | | | | | | |
| 4 | 0 = converter grade | | | | | | | | |
| 5 | C = ceramic PUK | | | | | | | | |
| 6 | Voltage code: code x 100 = V_{RRM} (see Voltage Ratings table) | | | | | | | | |
| 7 | C = PUK case A-PUK (TO-200AB) | | | | | | | | |
| 8 | 0 = eyelet terminals (gate and auxiliary cathode unsoldered leads) 1 = fast-on terminals (gate and auxiliary cathode unsoldered leads) 2 = eyelet terminals (gate and auxiliary cathode soldered leads) 3 = fast-on terminals (gate and auxiliary cathode soldered leads) | | | | | | | | |
| 9 | Critical dV/dt : • None = 500 V/ μs (standard selection) • L = 1000 V/ μs (special selection) | | | | | | | | |

LINKS TO RELATED DOCUMENTS

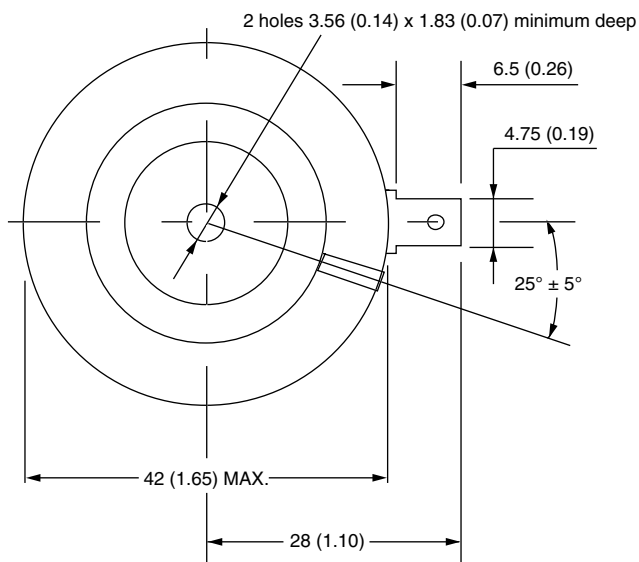
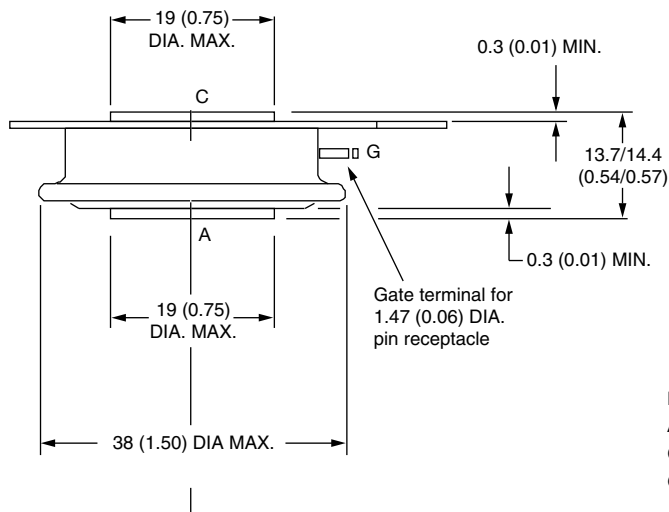
Dimensions

www.vishay.com/doc?95074

A-PUK (TO-200AB)

DIMENSIONS in millimeters (inches)

Anode to gate
Creepage distance: 7.62 (0.30) minimum
Strike distance: 7.12 (0.28) minimum



Quote between upper and lower pole pieces has to be considered after application of mounting force (see thermal and mechanical specification)



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